

# PNA1401LF, PNZ102F

## Silicon NPN Phototransistors

For optical control systems

### Features

- Flat window design which is suited to optical systems
- Low dark current :  $I_{CEO} = 5 \text{ nA}$  (typ.)
- Fast response :  $t_r, t_f = 3 \text{ } \mu\text{s}$  (typ.)
- Wide directional sensitivity
- Base pin for easy circuit design (PNZ102F)

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Collector to emitter voltage	$V_{CEO}$	30	V
Collector to base voltage	$V_{CBO}^*$	40	V
Emitter to collector voltage	$V_{ECO}$	5	V
Emitter to base voltage	$V_{EBO}^*$	5	V
Collector current	$I_C$	50	mA
Collector power dissipation	$P_C$	150	mW
Operating ambient temperature	$T_{opr}$	-25 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-30 to +100	$^\circ\text{C}$

\* PNZ102F only

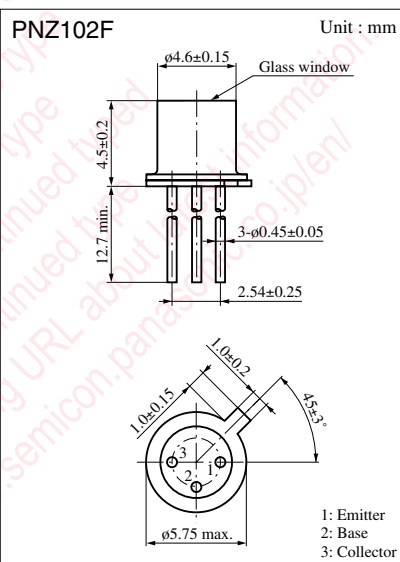
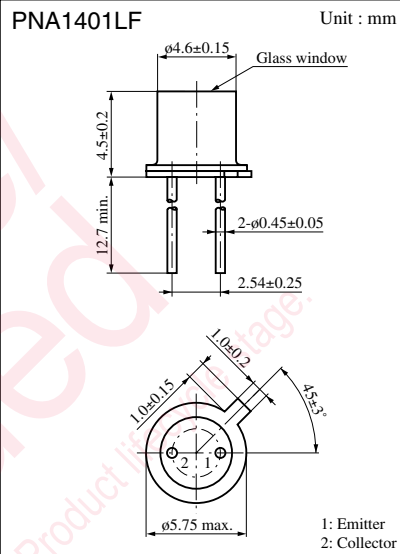


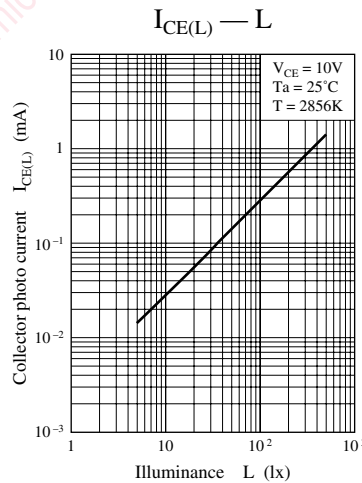
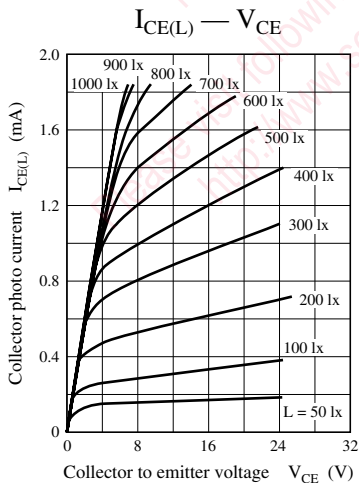
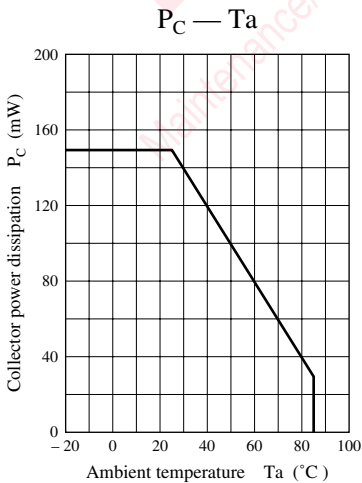
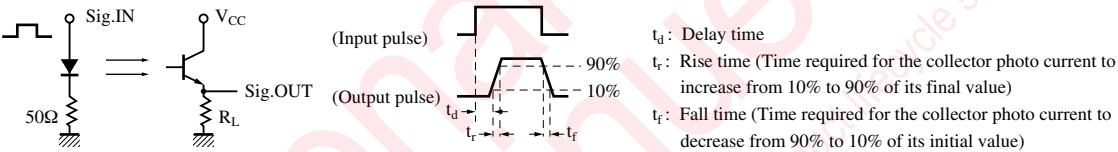
Photo-  
detectors

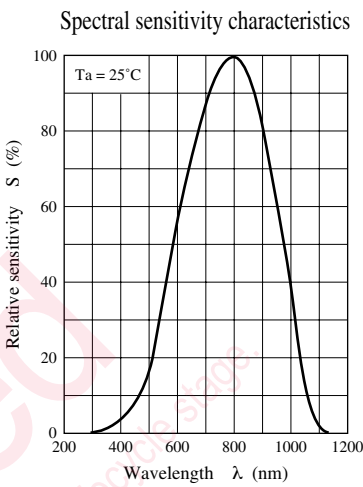
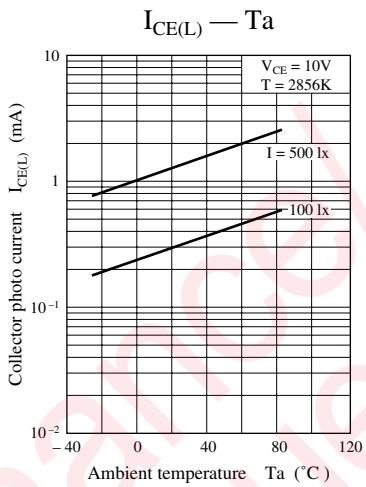
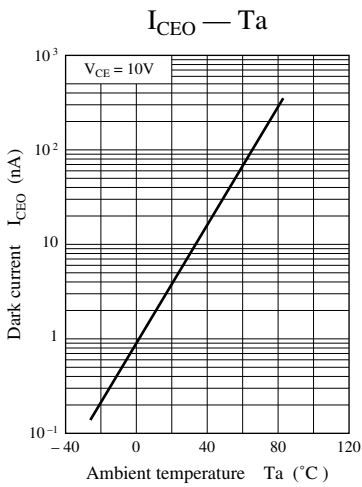
■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit	
Dark current	I <sub>CEO</sub>	V <sub>CE</sub> = 10V		5	300	nA	
Collector photo current	I <sub>CE(L)</sub>	V <sub>CE</sub> = 10V, L = 100 lx*1	0.1	0.3		mA	
Peak sensitivity wave length	λ <sub>p</sub>	V <sub>CE</sub> = 10V		800		nm	
Acceptance half angle	θ	Measured from the optical axis to the half power point		40		deg.	
Response time	t <sub>r</sub> , t <sub>f</sub> *2	V <sub>CC</sub> = 10V, I <sub>CE(L)</sub> = 5mA, R <sub>L</sub> = 100Ω		3		μs	
Collector saturation voltage	V <sub>CE(sat)</sub>	L = 500 lx*1	PNA1401LF I <sub>CE(L)</sub> = 0.1mA		0.2	0.4	V
			PNZ102F I <sub>CE(L)</sub> = 0.1mA				

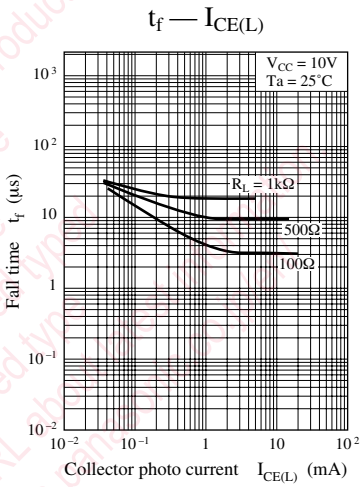
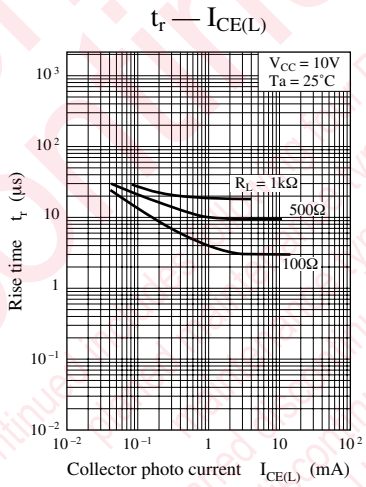
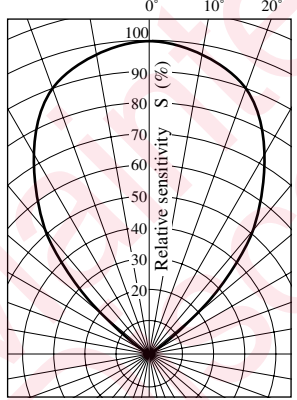
\*1 Measurements were made using a tungsten lamp (color temperature T = 2856K) as a light source.

\*2 Switching time measurement circuit





Directivity characteristics



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